

Description

Product Summary		
V _{DS} (V)	R _{DS(on)} (mΩ)(Typ)	I _D (A)
650	70@ V _{GS} = 12V	27

Feature

- Easy to use, compatible with standard gate drivers
- Excellent Q_G x R_{DS(on)} figure of merit (FOM)
- Low Q_{RR}, no free-wheeling diode required
- Low switching loss
- RoHS compliant and Halogen-free

Applications

- High efficiency power supplies
- Telecom and datacom
- Automotive
- Servo motors

Absolute maximum rating@25°C

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V _{DS}	650	V
Gate-Source Voltage	V _{GS}	±20	V
Transient Drain-Source Voltage ¹⁾	V _{TDS}	800	V
Continuous Drain Current	T _C =25°C	I _D	A
	T _C =100°C		
Pulsed Drain Current (Pulse Width: 100μs)	T _C =25°C	I _{DM}	A
	T _C =100°C		
Power Dissipation	P _D	93	W
Soldering Peak Temperature	T _{CSOLD}	260	°C
Operating Junction and Storage Temperature	T _J , T _{STG}	-55 to 150	°C

Thermal Resistance

Parameter	Symbol	Min	Typ	Max	Unit
Thermal Resistance, Junction-to-Case	R _{θJC}	-	1.34	-	°C/W
Thermal Resistance, Junction-to-Ambient ²⁾	R _{θJA}	-	50	-	°C/W

650V GaN Power Transistor

PGCTO65R70B

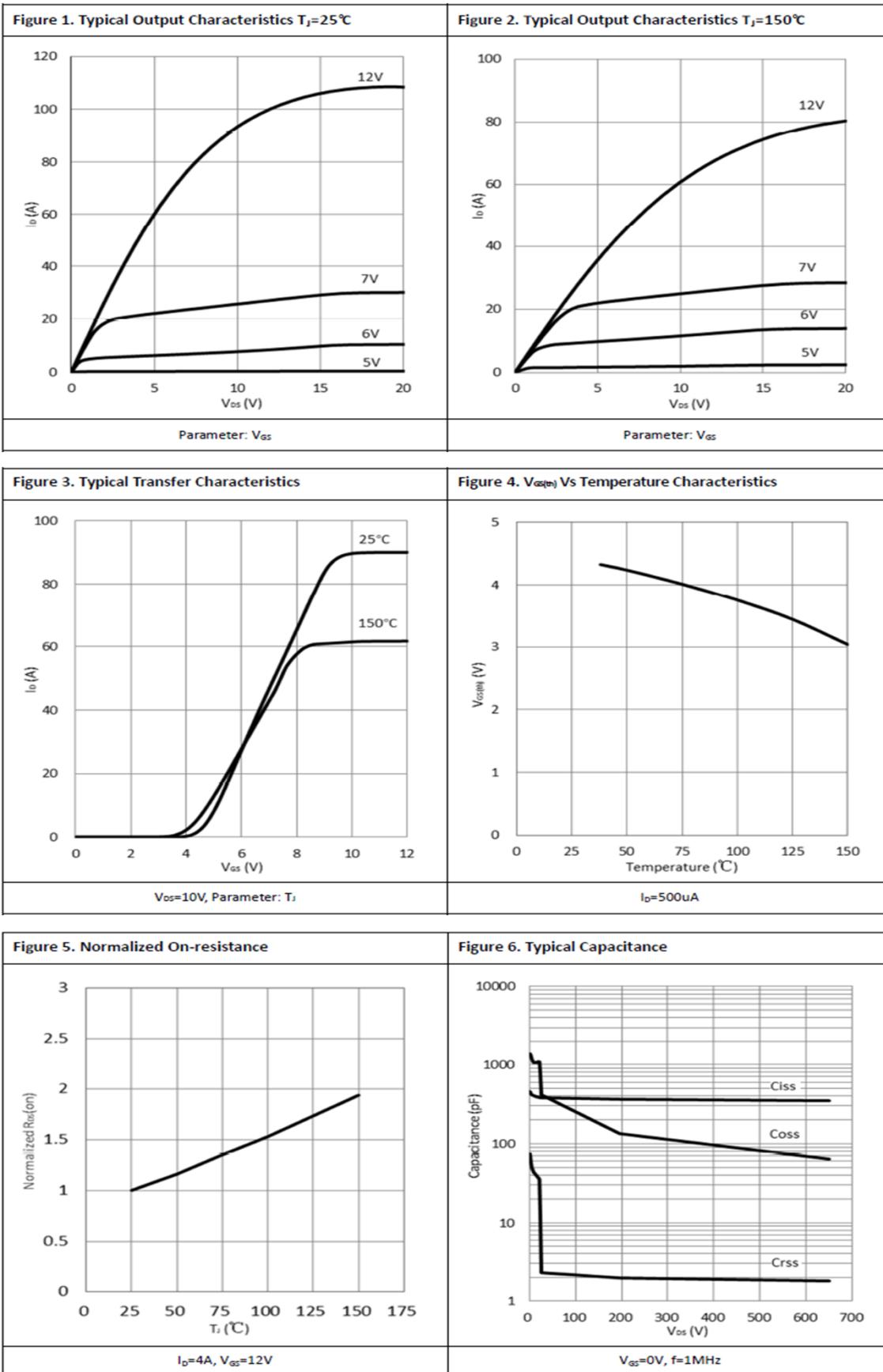
Electrical characteristics per line@25°C (unless otherwise specified)

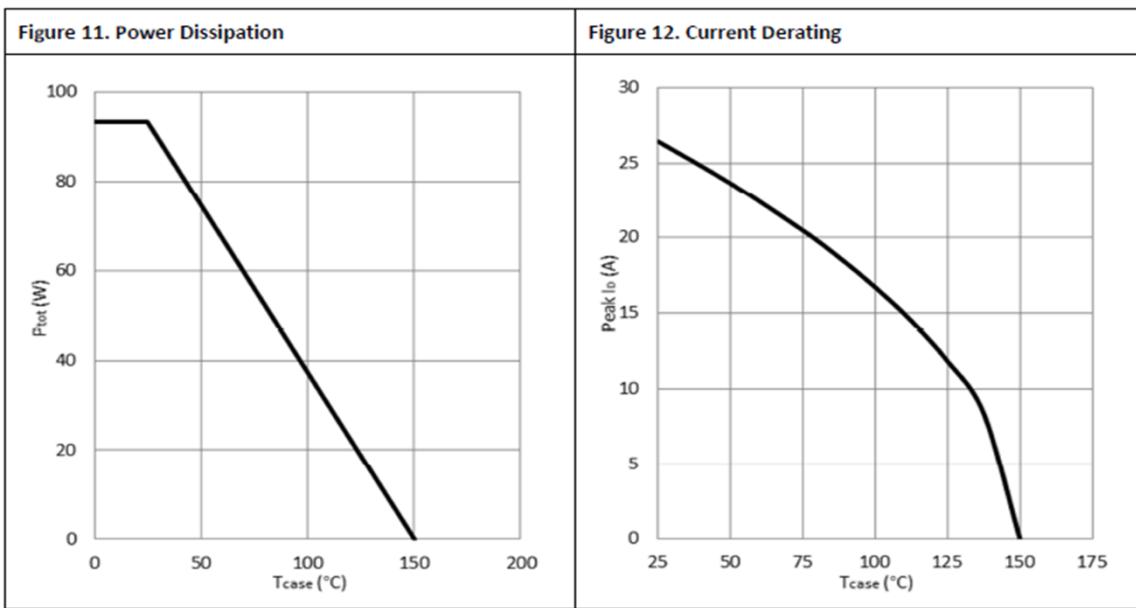
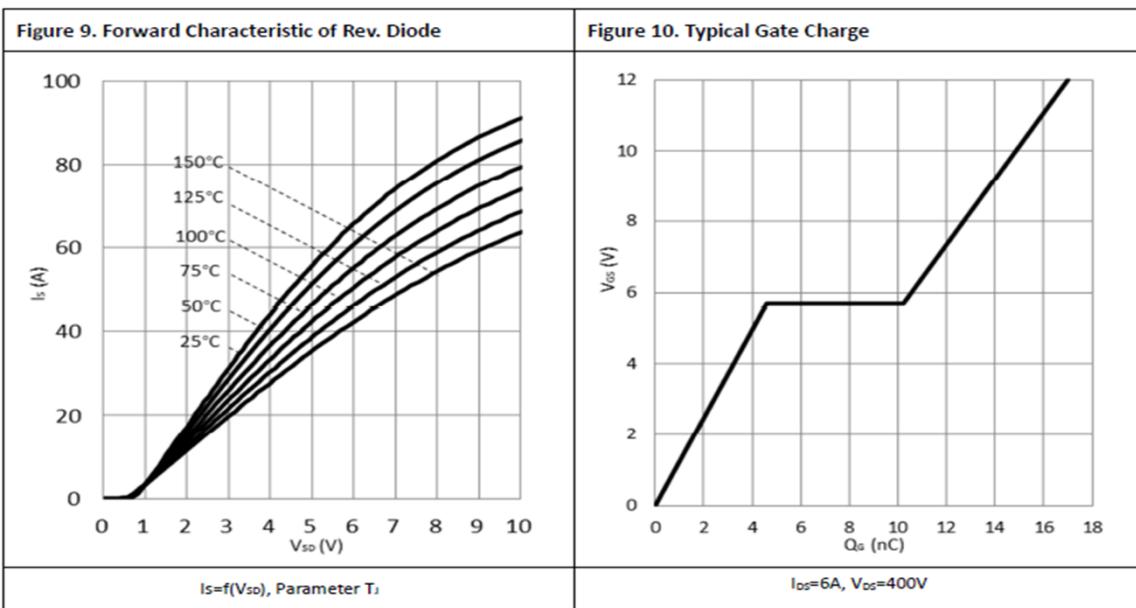
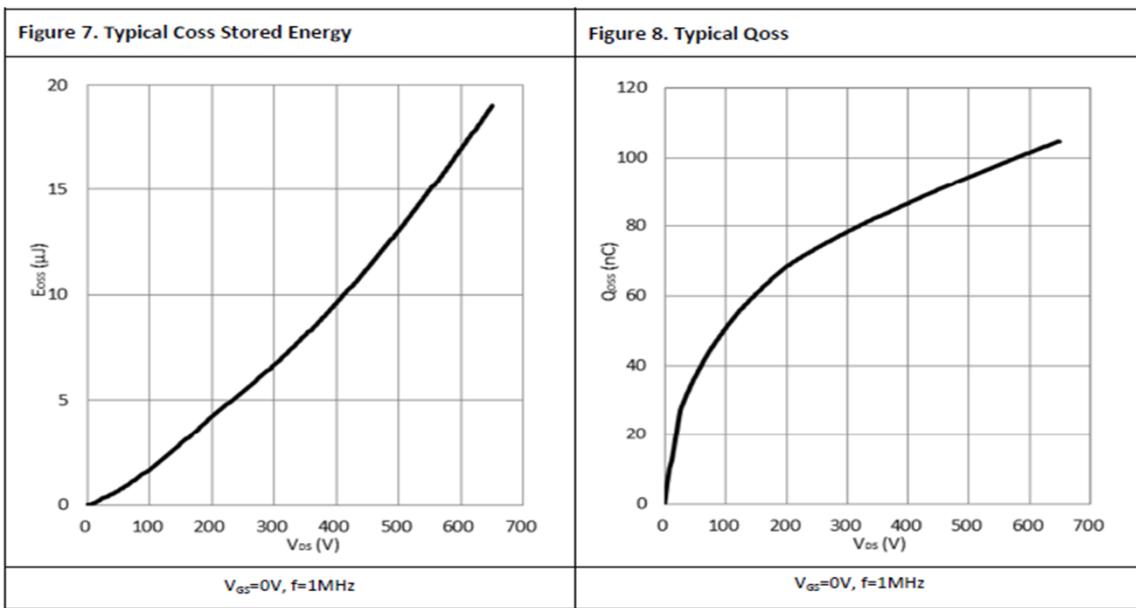
Parameter	Symbol	Conditions		Min.	Typ.	Max.	Units	
Statistic Characteristics								
Maximum Drain-Source Voltage	V _{DS-Max}	V _{GS} = 0V		650	-	-	V	
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} = 0V, I _D = 250μA		-	1000	-	V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =650V, V _{GS} =0V	T _J =25°C	-	10	30	μA	
			T _J =150°C	-	50	-		
Gate-Body Leakage Current	I _{GSS}	V _{GS} = ±20V, V _{DS} = 0V		-	-	±150	nA	
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 500μA	3.0	4.0	5.0	-	V	
Gate Threshold Voltage Temperature Coefficient	△V _{GS(th)} /T _J			-	-11.3	-	mV/°C	
Drain-Source On-State Resistance ³⁾	R _{DS(ON)}	V _{GS} =12V, I _D =4A	T _J =25°C	-	70	90	mΩ	
			T _J =150°C	-	140	-		
Dynamic Characteristics								
Input Capacitance	C _{iss}	V _{DS} = 400V, V _{GS} = 0V, f = 1MHz	V _{GS} = 0V, V _{DS} = 0-400V	-	354	-	pF	
Output Capacitance	C _{oss}			-	79.7	-		
Reverse Transfer Capacitance	C _{rss}			-	1.9	-		
Effective Output Capacitance, Energy Related	C _{o(er)}	V _{GS} = 0V, V _{DS} = 0-400V	V _{GS} = 0V, V _{DS} = 0-400V	-	120	-	pF	
Effective Output Capacitance, Time Related	C _{o(tr)}			-	217	-		
Output Charge	Q _{oss}			-	87	-	nC	
Turn-on Delay Time	t _{d(on)}	V _{DS} = 400V, I _D = 10A, V _{GS} = 0-12V, R _G = 40Ω	V _{GS} = 0V, V _{DS} = 0-400V	-	44	-	ns	
Turn-on Rise Time	t _r			-	16	-		
Turn-Off Delay Time	t _{d(off)}			-	40	-		
Turn-Off Fall Time	t _f			-	12	-		
Total Gate Charge	Q _g	V _{DS} = 400V, I _D = 6A, V _{GS} = 0-12V	V _{GS} = 0V, V _{DS} = 0-400V	-	17	-	nC	
Gate-Source Charge	Q _{gs}			-	4.6	-		
Gate-Drain Charge	Q _{gd}			-	5.6	-		
Reverse Diode Characteristics								
Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _S =8.5A		-	1.3	-	V	
		V _{GS} =0V, I _S =17A	T _J =25°C	-	1.9	-		
			T _J =150°C	-	3	-		
Reverse Recovery Time	t _{rr}	V _{GS} =0V, I _S =17A, V _{DD} =400V, di/dt=1000A/μs		-	33	-	ns	
Reverse Recovery Charge	Q _{rr}			-	87	-	μC	

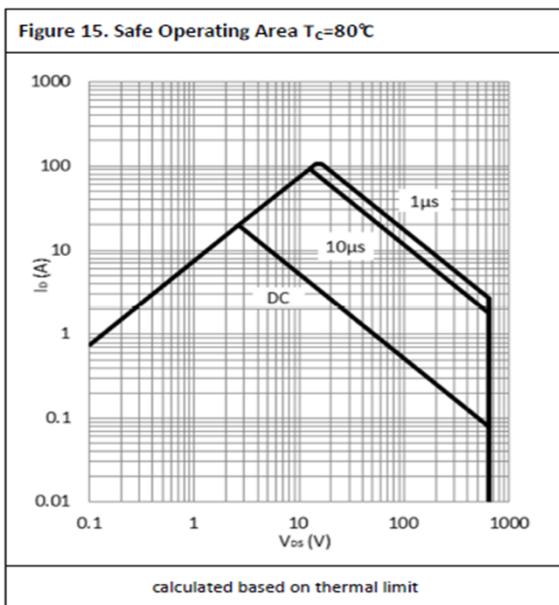
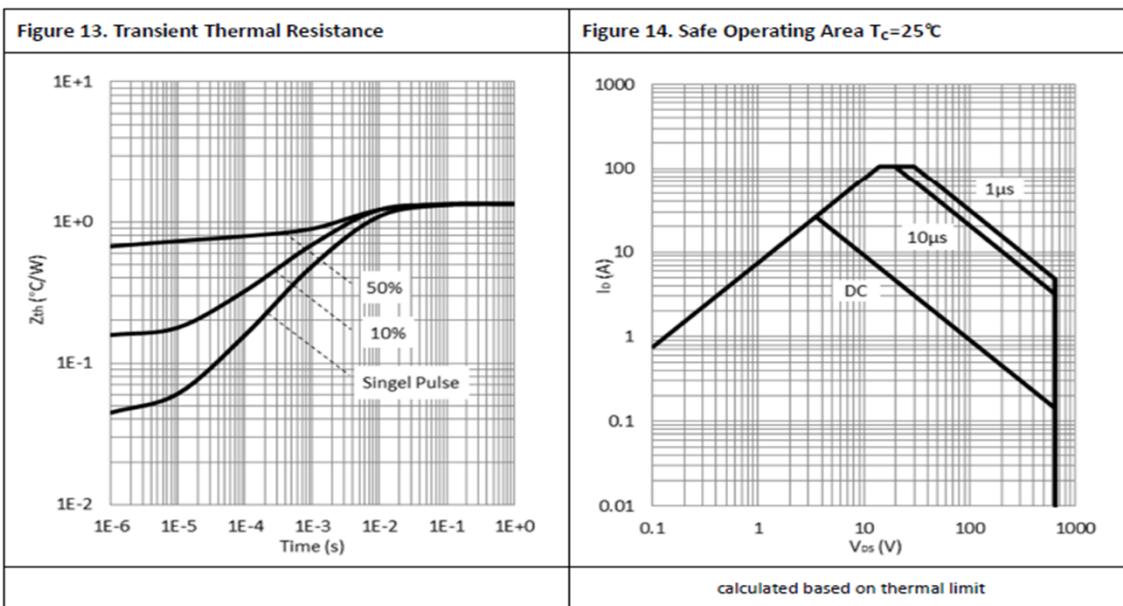
Notes:

1. Off-state spike duty cycle < 0.01, spike duration < 2μs
2. Device on one layer epoxy PCB for drain connection (vertical and without air stream cooling, with 6cm²copper area and 70μm thickness)
3. Dynamic on-resistance; see Figure 18 and 19 for test circuit and configurations

Typical Characteristics







Test Circuits and Waveforms

Figure 16. Switching Time Test Circuit

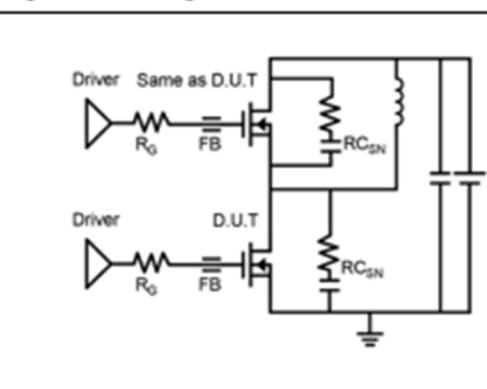


Figure 17. Switching Time Waveform

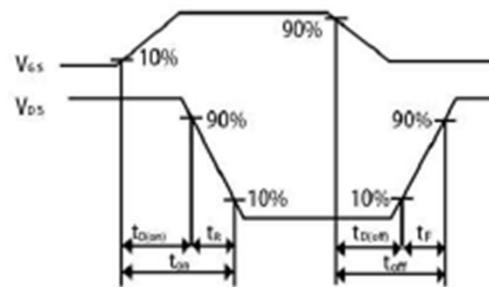


Figure 18. Dynamic R_DS(on) Test Circuit

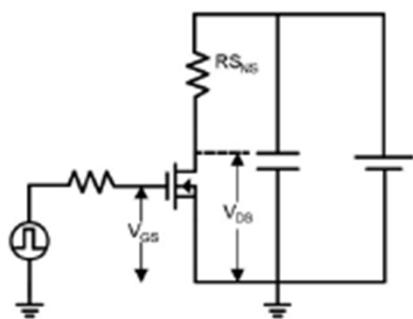


Figure 19. Dynamic R_DS(on) Waveform

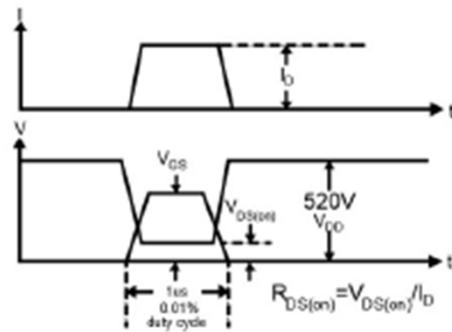


Figure 20. Diode Characteristic Test Circuits

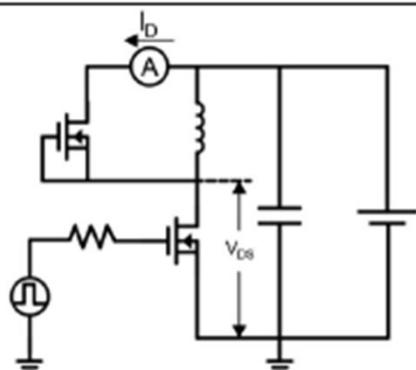
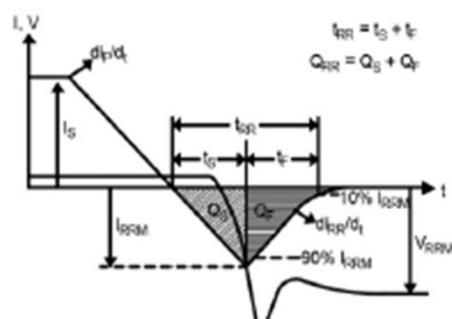
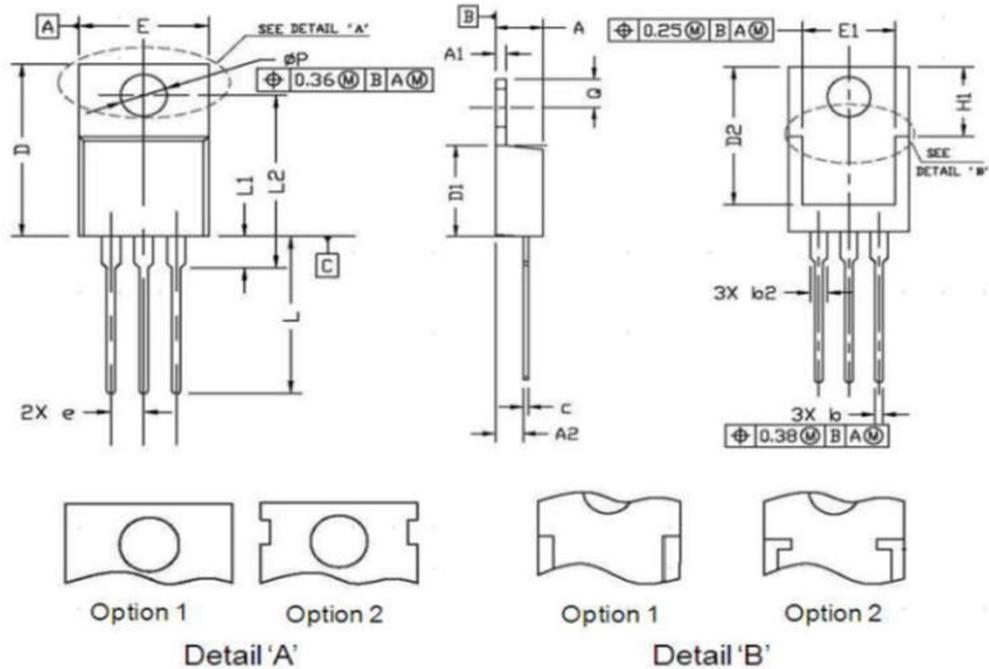


Figure 21. Diode Recovery Waveform



Product Dimension (TO-220)



SYMBOL	Millimeter	
	Min	Max
A	4.30	4.80
A1	1.20	1.45
A2	2.20	2.90
b	0.69	0.95
b2	1.00	1.60
c	0.33	0.65
D	14.70	16.20
D1	8.59	9.65
D2	11.75	13.60
e	2.54BSC	
E	9.60	10.60
E1	7.00	8.46
H1	6.20	7.00
L	12.60	14.80
L1	2.70	3.80
L2	12.13	16.50
Q	2.40	3.10
P	3.50	3.90

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